

1. Product Features

1.1 Electrical features

- $V_{CES}=1200V$
- $I_{C\ nom}=75A / I_{CRM}=150A$
- Low switching losses
- Low inductance
- Fast switching and short tail current
- Integrated NTC temperature sensor
- High power and thermal cycling capability



Figure1 IGBT Module

1.2 Mechanical features

- Al_2O_3 substrate with low thermal resistance
- Copper base plate

2. Typical Applications

- Switching mode power supply
- Drive inverters with brake system
- Uninterruptible power supply
- AC and DC servo drive amplifier

3. Description

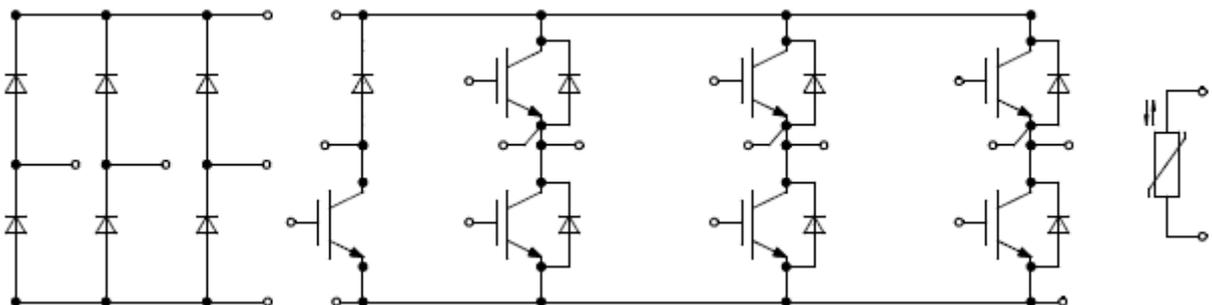


Figure 2 3 Phase Bridge +Rectifier+Brake

4. IGBT, Inverter

4.1 Maximum rated values

Parameter	Note or test condition	Symbol	Values	Unit
Collector-emitter voltage 集电极—发射极间电压	$T_{vj} = 25^{\circ}\text{C}$	V_{CES}	1200	V
Continuous DC collector current 连续集电极电流	$T_C = 100^{\circ}\text{C}, T_{vj\ max} = 150^{\circ}\text{C}$	$I_{C\ nom}$	75	A
Repetitive peak collector current 集电极峰值电流	$t_P = 1\ \text{ms}$	I_{CRM}	150	A
Total power dissipation 总功率损耗	$T_C = 25^{\circ}\text{C}, T_{vj\ max} = 175^{\circ}\text{C}$	P_{tot}	395	W
Gate-emitter peak voltage 栅极—发射极峰值电压		V_{GES}	+/- 20	V

4.2 Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter saturation voltage 集电极—发射极饱和电压	$I_C = 75\ \text{A}, V_{GE} = 15\ \text{V}$	$T_{vj} = 25^{\circ}\text{C}$		1.54		V
		$T_{vj} = 125^{\circ}\text{C}$		1.65		V
		$T_{vj} = 150^{\circ}\text{C}$		1.70		V
Gate threshold voltage 栅极阈值电压	$I_C = 1.5\ \text{mA}, V_{CE} = V_{GE}, T_{vj} = 25^{\circ}\text{C}$	$V_{GE,th}$	5.0	6.0	6.5	V
Gate charge 栅极电荷	$V_{GE} = -15\ \text{V} \dots +15\ \text{V}$	Q_G		0.81		μC
Internal gate resistor 内部栅极电阻	$T_{vj} = 25^{\circ}\text{C}$	R_{Gint}		2.70		Ω
Input capacitance 输入电容	$f=1\ \text{MHz}, T_{vj}=25^{\circ}\text{C}, V_{CE}=25\ \text{V}, V_{GE}=0\ \text{V}$	C_{ies}		9.80		nF
Reverse transfer capacitance 反向传输电容	$f=1\ \text{MHz}, T_{vj}=25^{\circ}\text{C}, V_{CE}=25\ \text{V}, V_{GE}=0\ \text{V}$	C_{res}		0.12		nF
Collector-emitter cut-off current 集电极-发射极截止电流	$V_{CE} = 1200\ \text{V}, V_{GE} = 0\ \text{V}, T_{vj} = 25^{\circ}\text{C}$	I_{CES}			1	mA
Gate-emitter leakage current 栅极-发射极漏电流	$V_{CE} = 0\ \text{V}, V_{GE} = 20\ \text{V}, T_{vj} = 25^{\circ}\text{C}$	I_{GES}			100	nA
Turn-on delay time, inductive load 开通延迟时间	$I_C = 75\ \text{A}, V_{CE} = 600\ \text{V}$ $V_{GE} = +15/-15\ \text{V}$ $R_{G,on} = 1\ \Omega$	$T_{vj} = 25^{\circ}\text{C}$		0.06		us
		$T_{vj} = 125^{\circ}\text{C}$		0.07		us
		$T_{vj} = 150^{\circ}\text{C}$		0.08		us
Rise time, inductive load 上升时间	$I_C = 75\ \text{A}, V_{CE} = 600\ \text{V}$ $V_{GE} = +15/-15\ \text{V}$ $R_{G,on} = 1\ \Omega$	$T_{vj} = 25^{\circ}\text{C}$		0.02		us
		$T_{vj} = 125^{\circ}\text{C}$		0.02		us
		$T_{vj} = 150^{\circ}\text{C}$		0.02		us

(table continues...) 待续

Parameter	Note or test condition	Symbol	Values			Unit	
			Min.	Typ.	Max.		
Turn-off delay time, inductive load 关断延迟时间	I _C = 75A, V _{CE} = 600V V _{GE} = +15/-15V R _{G,off} = 1Ω	T _{vj} = 25°C T _{vj} = 125°C T _{vj} = 150°C	t _{d,off}		0.20		us
					0.24		us
					0.25		us
Fall time, inductive load 下降时间	I _C = 75A, V _{CE} = 600V V _{GE} = +15/-15V R _{G,off} = 1Ω	T _{vj} = 25°C T _{vj} = 125°C T _{vj} = 150°C	t _f		0.24		us
					0.38		us
					0.40		us
Turn-on energy loss per pulse 开通损耗能量	I _C = 75A, V _{CE} = 600V, L _S =30nH V _{GE} = +15/-15V, di/dt =2520A/μs R _{G,on} = 1Ω (T _{vj} = 150°C)	T _{vj} = 25°C T _{vj} = 125°C T _{vj} = 150°C	E _{on}		2.52		mJ
					3.93		mJ
					4.35		mJ
Turn-off energy loss per pulse 关断损耗能量	I _C = 75A, V _{CE} = 600V, L _S =30nH V _{GE} = +15/-15V, dv/dt =4500V/μs R _{G,off} = 1Ω (T _{vj} = 150°C)	T _{vj} = 25°C T _{vj} = 125°C T _{vj} = 150°C	E _{off}		5.84		mJ
					8.53		mJ
					9.11		mJ
SC data 短路数据	V _{GE} ≤ 15V, V _{CC} = 600V, t _p ≤ 8 μs, T _{vj} = 150°C, C _{GE} = 0.0uF, V _{CEmax} = V _{CEs} - L _{SCE} · di/dt	I _{sc}		570		A	
Thermal resistance, junction to case 结—外壳热阻	Per IGBT	R _{th,Jc}			0.38	K/W	

5. Diode, Inverter

5.1 Maximum rated values

Parameter	Note or test condition	Symbol	Values	Unit
Repetitive peak reverse voltage 反向重复峰值电压	T _{vj} = 25°C	V _{RRM}	1200	V
Continuous DC forward current 连续正向直流电流		I _F	75	A
Repetitive peak forward current 正向重复峰值电流	t _p = 1 ms	I _{FRM}	150	A

5.2 Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Forward voltage 正向电压	I _F = 75 A, V _{GE} = 0 V	V _F		1.83		V
				1.82		V
				1.77		V

(table continues...) 待续

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Peak reverse recovery current 反向恢复峰值电流	$I_F = 75A, V_R = 600V$	$T_{vj} = 25^\circ C$		169		A
	$V_{GE} = -15V, -di_F/dt = 5320 A/\mu s$	$T_{vj} = 125^\circ C$	I_{RM}	181		A
	$R_G = 1\Omega (T_{vj} = 150^\circ C)$	$T_{vj} = 150^\circ C$		184		A
Recovered charge 恢复电荷	$I_F = 75A, V_R = 600V$	$T_{vj} = 25^\circ C$		6.43		μC
	$V_{GE} = -15V, -di_F/dt = 5320 A/\mu s$	$T_{vj} = 125^\circ C$	Q_r	9.29		μC
	$R_G = 1\Omega (T_{vj} = 150^\circ C)$	$T_{vj} = 150^\circ C$		10.3		μC
Reverse recovery energy 反向恢复损耗 (每脉冲)	$I_F = 75A, V_R = 600V$	$T_{vj} = 25^\circ C$		1.32		mJ
	$V_{GE} = -15V, -di_F/dt = 5320 A/\mu s$	$T_{vj} = 125^\circ C$	E_{rec}	2.33		mJ
	$R_G = 1\Omega (T_{vj} = 150^\circ C)$	$T_{vj} = 150^\circ C$		2.64		mJ
Thermal resistance, junction to case 结-外壳热阻	Per diode	$R_{th,JC}$			0.45	K/W

6. Diode, Rectifier

6.1 Maximum rated values

Parameter	Note or test condition	Symbol	Values	Unit
Repetitive peak reverse voltage 反向重复峰值电压	$T_{vj} = 25^\circ C$	V_{RRM}	1600	V
Average Rectified Output current 整流器输出均方根电流	$V_F = 1.2, T_{vj} = 150^\circ C$	I_F	75	A
Surge forward current 正向浪涌电流	$t_p = 10 ms, T_{vj} = 150^\circ C$	I_{FSM}	515	A
I^2t - value I^2t -值	$t_p = 10 ms, T_{vj} = 150^\circ C$	I^2t	1330	A^2s

6.2 Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Forward voltage 正向电压	$T_{vj} = 150^\circ C, I_F = 75 A$	V_F		1.10		V
Reverse current 反向电流	$T_{vj} = 150^\circ C, V_R = 1600 V$	I_R		1.00		mA
Thermal resistance, junction to case 结-外壳热阻	Per diode	$R_{th,JC}$			0.43	K/W

7. IGBT, Brake-Chopper

7.1 Maximum rated values

Parameter	Note or test condition	Symbol	Values	Unit
Collector-emitter voltage 集电极—发射极间电压	$T_{vj} = 25^{\circ}\text{C}$	V_{CES}	1200	V
Continuous DC collector current 连续集电极电流	$T_C = 100^{\circ}\text{C}, T_{vj\ max} = 150^{\circ}\text{C}$	$I_{C\ nom}$	50	A
Repetitive peak collector current 集电极峰值电流	$t_P = 1\ \text{ms}$	I_{CRM}	100	A
Total power dissipation 总功率损耗	$T_C = 25^{\circ}\text{C}, T_{vj\ max} = 175^{\circ}\text{C}$	P_{tot}	260	W
Gate-emitter peak voltage 栅极—发射极峰值电压		V_{GES}	+/- 20	V

7.2 Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter saturation voltage 集电极—发射极饱和电压	$I_C = 50\ \text{A}, V_{GE} = 15\ \text{V}$	$V_{CE, sat}$		$T_{vj} = 25^{\circ}\text{C}$	1.67	V
				$T_{vj} = 125^{\circ}\text{C}$	1.92	V
				$T_{vj} = 150^{\circ}\text{C}$	2.00	V
Gate threshold voltage 栅极阈值电压	$I_C = 1.5\ \text{mA}, V_{CE} = V_{GE}, T_{vj} = 25^{\circ}\text{C}$	$V_{GE, th}$	5.0	5.8	6.5	V
Gate charge 栅极电荷	$V_{GE} = -15\ \text{V} \dots +15\ \text{V}$	Q_G		0.44		μC
Internal gate resistor 内部栅极电阻	$T_{vj} = 25^{\circ}\text{C}$	R_{Gint}		2.20		Ω
Input capacitance 输入电容	$f = 1\ \text{MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\ \text{V}, V_{GE} = 0\ \text{V}$	C_{ies}		6.15		nF
Reverse transfer capacitance 反向传输电容	$f = 1\ \text{MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\ \text{V}, V_{GE} = 0\ \text{V}$	C_{res}		0.08		nF
Collector-emitter cut-off current 集电极-发射极截止电流	$V_{CE} = 1200\ \text{V}, V_{GE} = 0\ \text{V}, T_{vj} = 25^{\circ}\text{C}$	I_{CES}			1	mA
Gate-emitter leakage current 栅极-发射极漏电流	$V_{CE} = 0\ \text{V}, V_{GE} = 20\ \text{V}, T_{vj} = 25^{\circ}\text{C}$	I_{GES}			100	nA
Turn-on delay time, inductive load 开通延迟时间	$I_C = 50\ \text{A}, V_{CE} = 600\ \text{V}$ $V_{GE} = +15/-15\ \text{V}$ $R_{G, on} = 3.3\ \Omega$	$t_{d, on}$		$T_{vj} = 25^{\circ}\text{C}$	0.03	μs
				$T_{vj} = 125^{\circ}\text{C}$	0.03	μs
				$T_{vj} = 150^{\circ}\text{C}$	0.03	μs
Rise time, inductive load 上升时间	$I_C = 50\ \text{A}, V_{CE} = 600\ \text{V}$ $V_{GE} = +15/-15\ \text{V}$ $R_{G, on} = 3.3\ \Omega$	t_r		$T_{vj} = 25^{\circ}\text{C}$	0.03	μs
				$T_{vj} = 125^{\circ}\text{C}$	0.03	μs
				$T_{vj} = 150^{\circ}\text{C}$	0.03	μs

(table continues...) 待续

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Turn-off delay time, inductive load 关断延迟时间	$I_C = 50A, V_{CE} = 600V$ $V_{GE} = +15/-15V$ $R_{G,off} = 3.3\Omega$	$T_{vj} = 25^\circ C$		0.15		us
		$T_{vj} = 125^\circ C$		0.18		us
		$T_{vj} = 150^\circ C$		0.19		us
Fall time, inductive load 下降时间	$I_C = 50A, V_{CE} = 600V$ $V_{GE} = +15/-15V$ $R_{G,off} = 3.3\Omega$	$T_{vj} = 25^\circ C$		0.23		us
		$T_{vj} = 125^\circ C$		0.34		us
		$T_{vj} = 150^\circ C$		0.36		us
Turn-on energy loss per pulse 开通损耗能量	$I_C = 50A, V_{CE} = 600V, L_s = 30nH$ $V_{GE} = +15/-15V, di/dt = 2250A/\mu s$ $R_{G,on} = 3.3\Omega (T_{vj} = 150^\circ C)$	$T_{vj} = 25^\circ C$		1.52		mJ
		$T_{vj} = 125^\circ C$		2.19		mJ
		$T_{vj} = 150^\circ C$		2.43		mJ
Turn-off energy loss per pulse 关断损耗能量	$I_C = 50A, V_{CE} = 600V, L_s = 30nH$ $V_{GE} = +15/-15V, dv/dt = 5900V/\mu s$ $R_{G,off} = 3.3\Omega (T_{vj} = 150^\circ C)$	$T_{vj} = 25^\circ C$		3.33		mJ
		$T_{vj} = 125^\circ C$		4.87		mJ
		$T_{vj} = 150^\circ C$		5.23		mJ
SC data 短路数据	$V_{GE} \leq 15V, V_{CC} = 600V, t_P \leq 8\mu s, T_{vj} = 150^\circ C,$ $C_{GE} = 0.0\mu F, V_{CEmax} = V_{CES} - L_{SCE} \cdot di/dt$	I_{sc}		350		A
Thermal resistance, junction to case 结-外壳热阻	Per IGBT	$R_{th,jc}$			0.50	K/W

8. Diode, Brake-Chopper

8.1 Maximum rated values

Parameter	Note or test condition	Symbol	Values	Unit
Repetitive peak reverse voltage 反向重复峰值电压	$T_{vj} = 25^\circ C$	V_{RRM}	1200	V
Continuous DC forward current 连续正向直流电流		I_F	50	A
Repetitive peak forward current 正向重复峰值电流	$t_P = 1ms$	I_{FRM}	100	A

8.2 Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Forward voltage 正向电压	$I_F = 50A, V_{GE} = 0V$	$T_{vj} = 25^\circ C$		2.13		V
		$T_{vj} = 125^\circ C$		2.06		V
		$T_{vj} = 150^\circ C$		1.96		V

(table continues...) 待续

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Peak reverse recovery current 反向恢复峰值电流	$I_F = 50A, V_R = 600V$	$T_{vj} = 25^\circ C$		71.6		A
	$V_{GE} = -15V, -di_F/dt = 4920 A/\mu s$	$T_{vj} = 125^\circ C$	I_{RM}	71.9		A
	$R_{G,on} = 3.3\Omega (T_{vj}=150^\circ C)$	$T_{vj} = 150^\circ C$		72.1		A
Recovered charge 恢复电荷	$I_F = 50A, V_R = 600V$	$T_{vj} = 25^\circ C$		3.83		μC
	$V_{GE} = -15V, -di_F/dt = 4920 A/\mu s$	$T_{vj} = 125^\circ C$	Q_r	6.26		μC
	$R_{G,on} = 3.3\Omega (T_{vj}=150^\circ C)$	$T_{vj} = 150^\circ C$		7.00		μC
Reverse recovery energy 反向恢复损耗 (每脉冲)	$I_F = 50A, V_R = 600V$	$T_{vj} = 25^\circ C$		0.69		mJ
	$V_{GE} = -15V, -di_F/dt = 4920 A/\mu s$	$T_{vj} = 125^\circ C$	E_{rec}	1.31		mJ
	$R_{G,on} = 3.3\Omega (T_{vj}=150^\circ C)$	$T_{vj} = 150^\circ C$		1.68		mJ
Thermal resistance, junction to case 结-外壳热阻	Per diode	$R_{th,Jc}$			0.54	K/W

9. NTC-Thermistor

9.1 Characteristic value

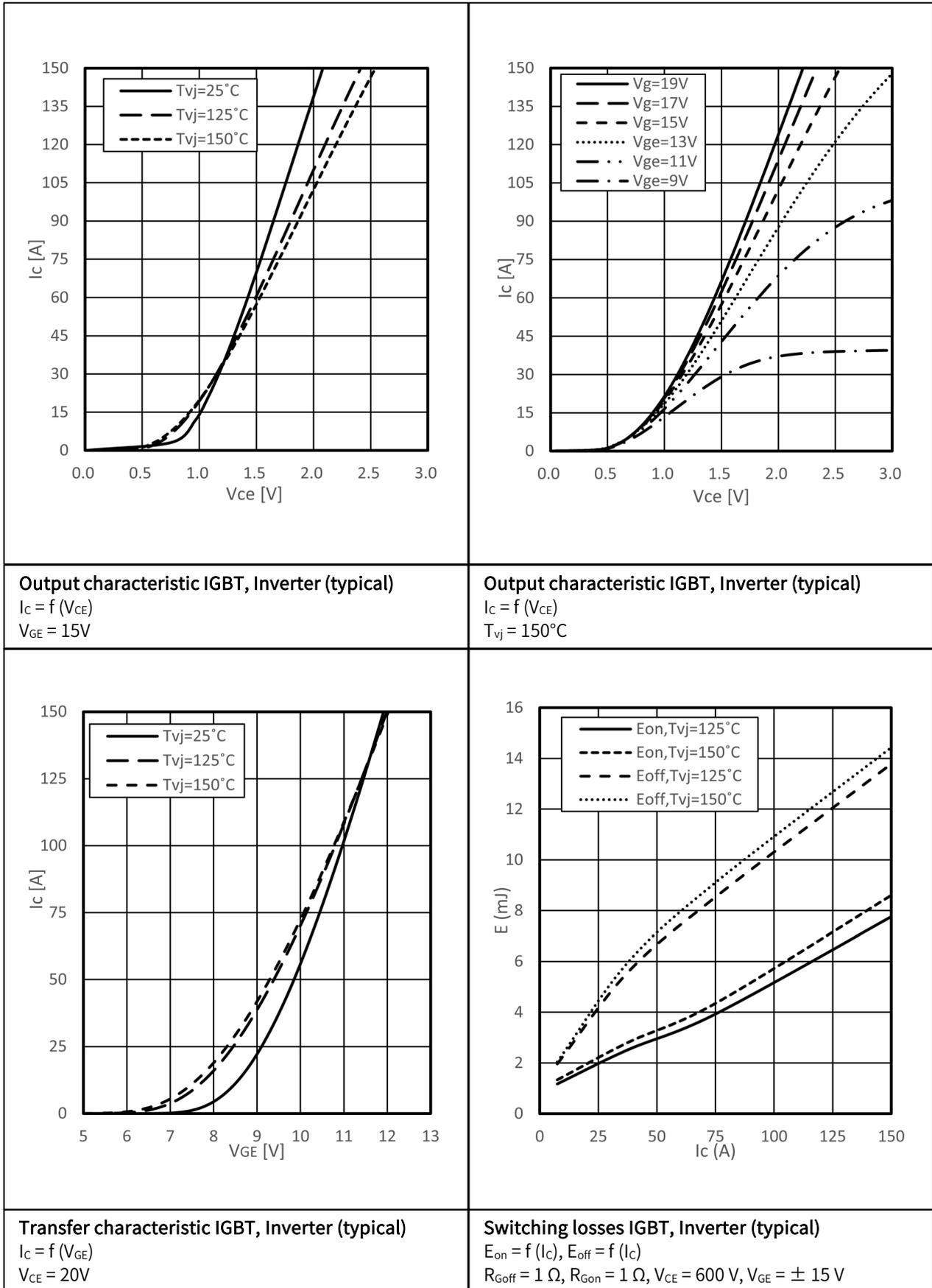
Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Rated resistance 额定电阻值	$T_c = 25^\circ C$	R_{25}		5.00		K Ω
Power dissipation 耗散功耗	$T_c = 25^\circ C$	P_{25}			20	mW
B-value B-Z 值	$R_2 = R_{25} \exp[B_{25/50}(1/T_2 - 1/(298, 15K))]$	B_{25}/B_{50}		3400		K
B-value B-Z 值	$R_2 = R_{25} \exp[B_{25/75}(1/T_2 - 1/(298, 15K))]$	B_{25}/B_{75}		3430		K
B-value B-Z 值	$R_2 = R_{25} \exp[B_{25/100}(1/T_2 - 1/(298, 15K))]$	B_{25}/B_{100}		3445		K

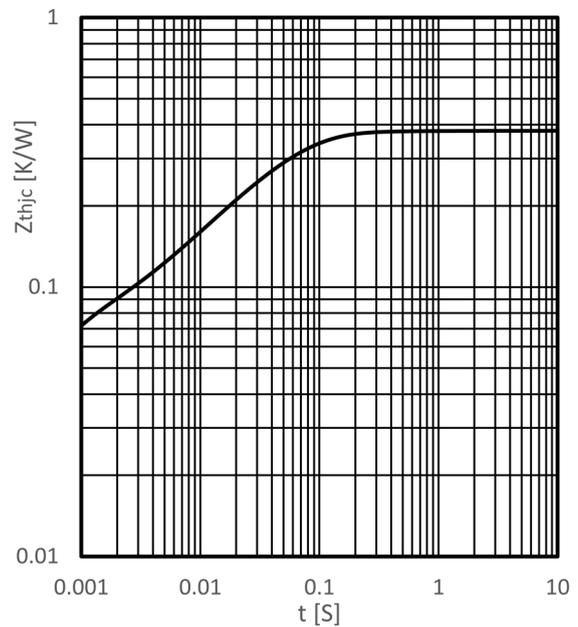
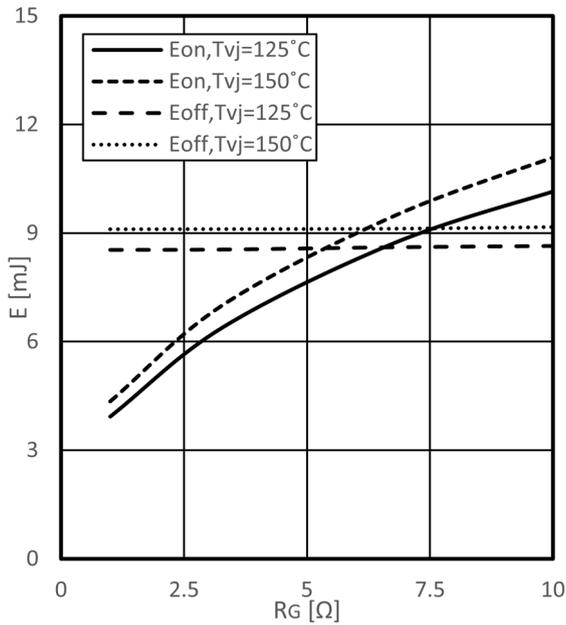
10. Module

10.1 Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Isolation Voltage 隔离电压	RMS, f=50HZ,1min	V _{ISOL}			2500	V
Stray inductance module 杂散电感		L _{SCE}		60		nH
Operation Junction Temperature 结温		T _{JOP}	-40		150	°C
Storage Temperature Range 存储温度范围		T _{stg}	-40		125	°C
Mounting Torque 安装扭矩	Screw M5	M	3		6	N.m
Weight of Module 重量		G		300		g

11. Characteristics diagrams





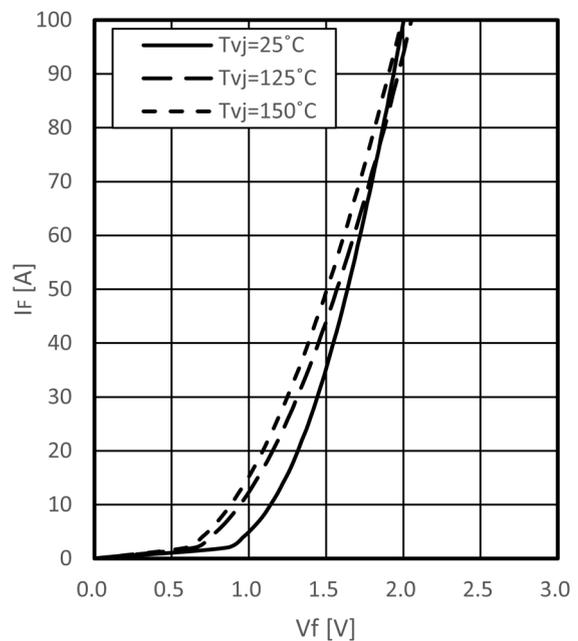
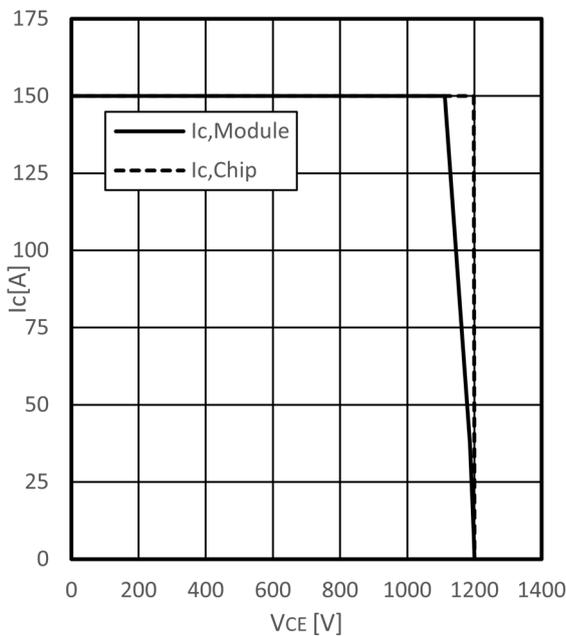
Switching losses IGBT, Inverter (typical)

$$E_{on} = f(R_G), E_{off} = f(R_G)$$

$$I_C = 75 \text{ A}, V_{CE} = 600 \text{ V}, V_{GE} = \pm 15 \text{ V}$$

Transient thermal impedance IGBT, Inverter

$$Z_{thjC} = f(t)$$



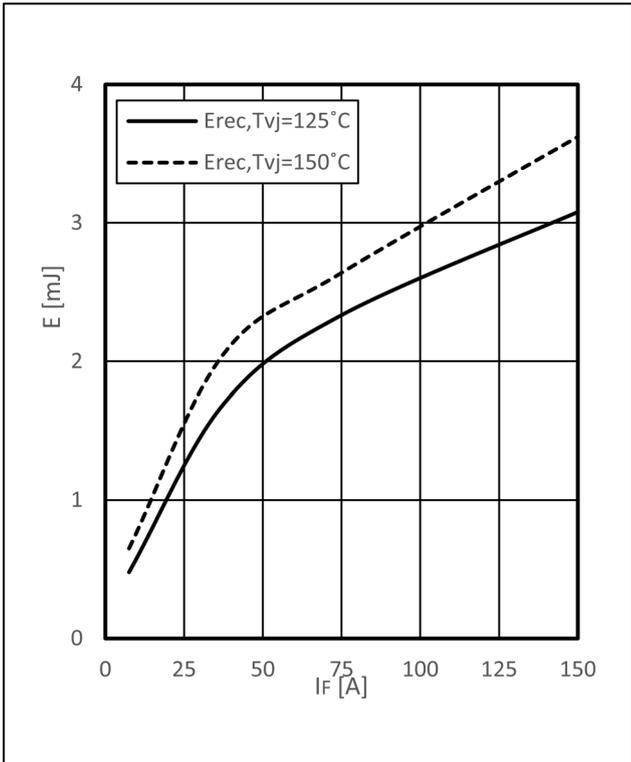
Reverse bias safe operating area IGBT, Inverter (RBSOA)

$$I_C = f(V_{CE})$$

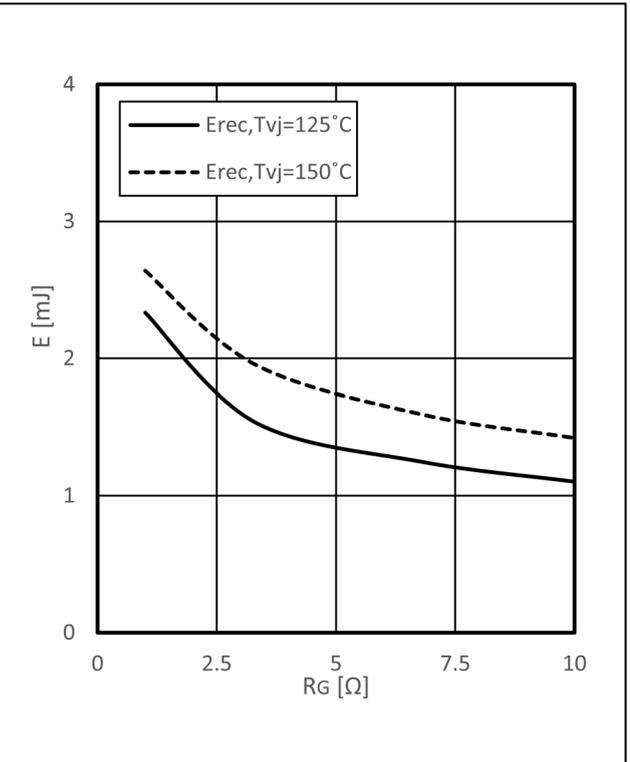
$$V_{GE} = 15 \text{ V}, R_{Goff} = 1 \Omega, T_{vj} = 150^\circ C$$

Forward characteristic of Diode, Inverter (typical)

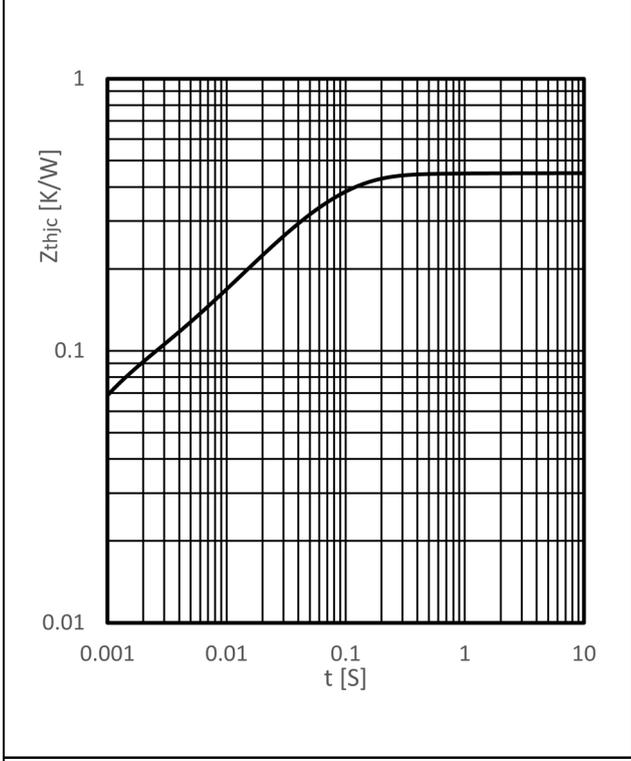
$$I_F = f(V_f)$$



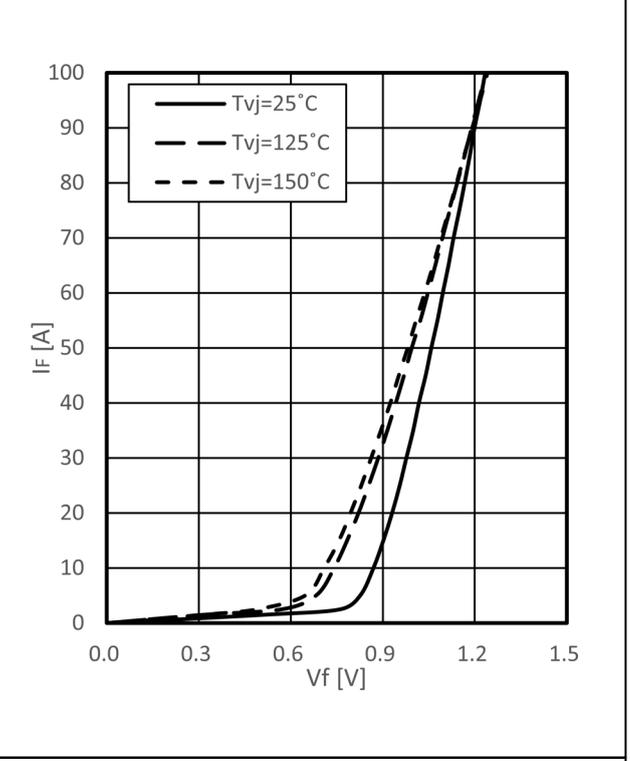
Switching losses Diode, Inverter (typical)
 $E_{rec} = f(I_F)$
 $R_{Gon} = 1 \Omega, V_{CE} = 600 V$



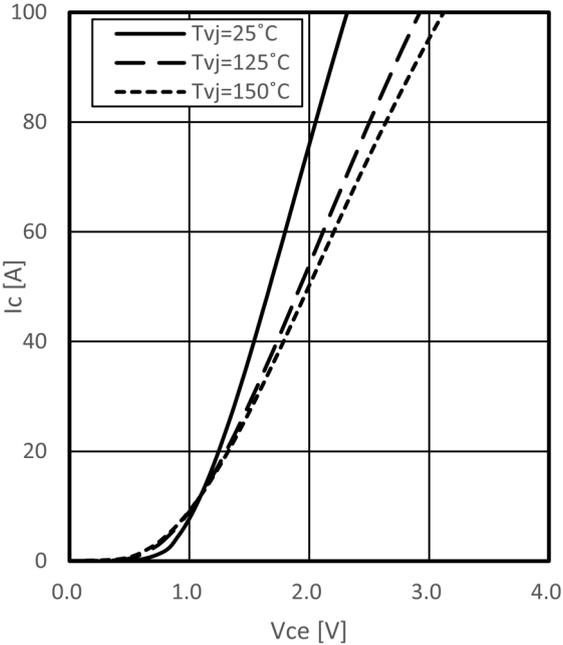
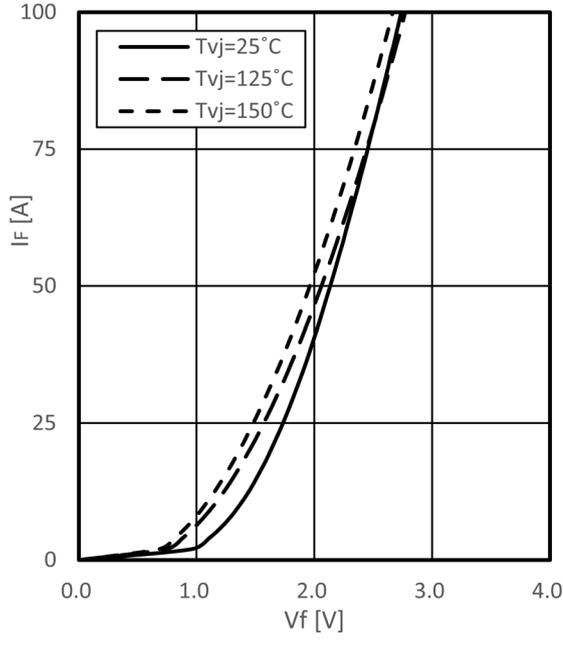
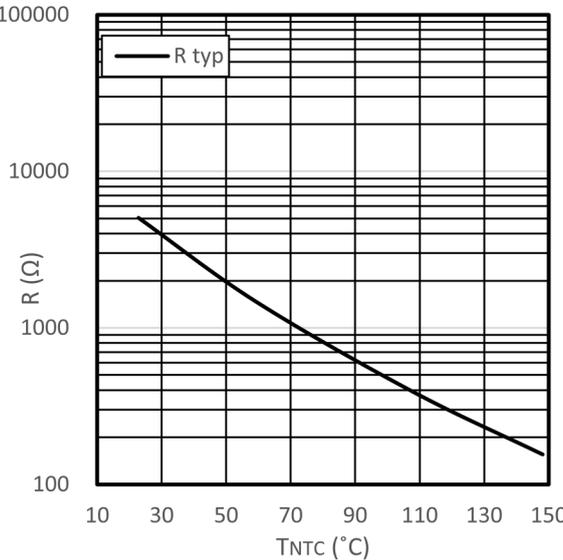
Switching losses Diode, Inverter (typical)
 $E_{rec} = f(R_G)$
 $I_F = 75 A, V_{CE} = 600 V$



Transient thermal impedance Diode, Inverter
 $Z_{thJC} = f(t)$



Forward characteristic of Diode, Rectifier (typical)
 $I_F = f(V_F)$

	
<p>Output characteristic IGBT, Brake-Chopper (typical) $I_C = f(V_{CE})$ $V_{GE} = 15V$</p>	<p>Forward characteristic of Diode, Brake-Chopper (typical) $I_F = f(V_F)$</p>
	
<p>NTC-Thermistor-temperature characteristic (typical) $R = f(T_{NTC})$</p>	

12. Circuit Diagram

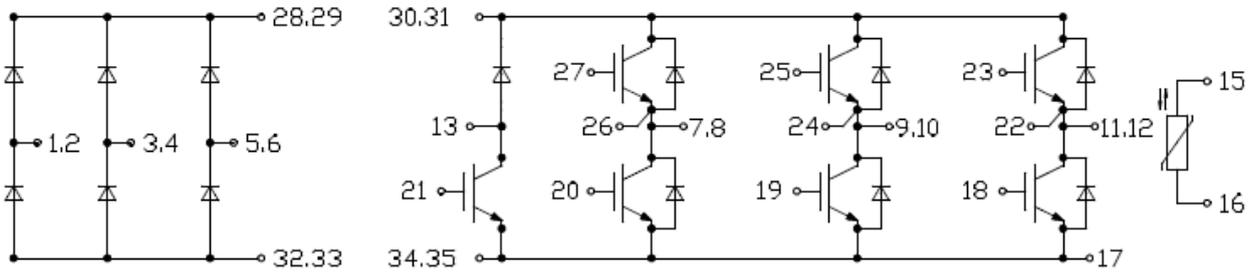


Figure 3

13. Package Outlines

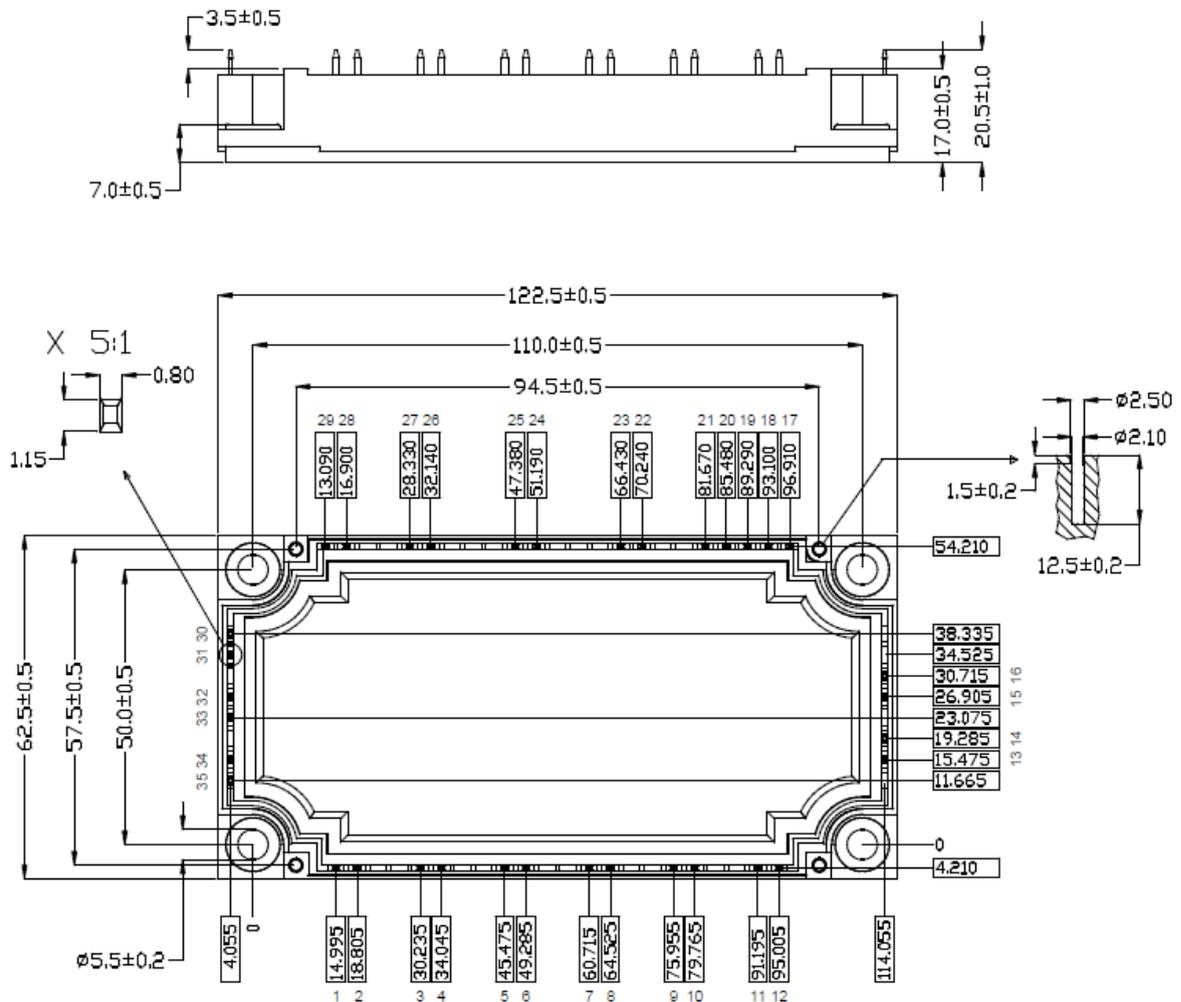


Figure 4